

# **DATASHEET**

## **30-01UYC**

## **Features**

- . High Flux Output.
- . Designed for High Current Operation.
- . Low Thermal Resistance.
- . Low Profile.
- . Packaged in Tubes for Use with Automatic.
- . Insertion Equipment.
- . The product itself will remain within RoHS compliant version.
- . Compliance with EU REACH.
- . Compliance Halogen Free . (Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).



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# **Descriptions**

This revolutionary package design allows the light designer to reduce the number of LEDs required and provide a more uniform and unique illuminated appearance than with other LED solutions. This is possible through the efficient optical package design and high-current capabilities.

The low profile package can be easily coupled with reflectors or lenses to efficiently distribute light and provide the desired light appearance.

# **Applications**

- . Automotive Exterior Lighting
- . Electronic Signs and Signals
- . Special Lighting application

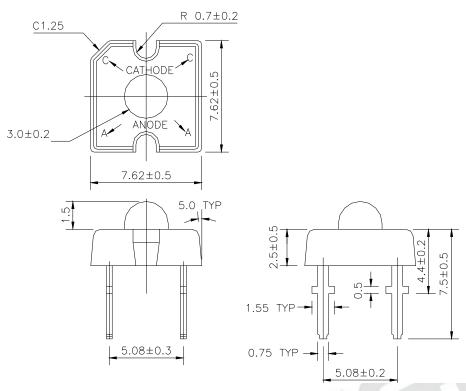
## **Device Selection Guide**

	C		
PART NO.	Material	<b>Emitted Color</b>	Lens Color
30-01UYC	AlGaInP	Yellow	Water Clear

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LifecyclePhase: Expired Period: Forever Expired Period: Forever

# **Package Dimensions**



**Notes:** 1.All dimensions are in millimeters

- 2.An epoxy meniscus may extend about 1.5mm(0.059") down the leads
- 3.Tolerances unless dimensions ±0.25mm

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# **Absolute Maximum Ratings (Ta=25)**

Parameter	Symbol	Rating	Units
Continuous Forward Current	$I_{\mathrm{F}}$	70	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	$T_{ m opr}$	-40 <b>~</b> +85	
Storage Temperature	$T_{ m stg}$	-40 ~ +100	
Soldering Temperature(T=5 sec)	$T_{\rm sol}$	260 ± 5	
LED Junction Temperature	$T_{j}$	115	
Power Dissipation	P <sub>d</sub>	220	mW
Electrostatic Discharge	ESD	2000	V

**Expired Period: Forever** 

# **Electro-Optical Characteristics (Ta=25)**

Parameter	Symbol	Min.	Тур.	Max.	Condition	Unit
Total Flux	V	1425	2000	3600	I <sub>F</sub> =70mA	mlm
Viewing Angle	2 1/2		80		I <sub>F</sub> =70mA	deg
Peak Wavelength	p		591		I <sub>F</sub> =20mA	nm
<b>Dominant Wavelength</b>	d	586	589	594	I <sub>F</sub> =20mA	nm
Spectrum Radiation Bandwidth			15		I <sub>F</sub> =20mA	nm
Forward Voltage	VF	1.9	2.4	2.7	I <sub>F</sub> =70mA	V
Reverse Current	IR			10	V <sub>R</sub> =5V	μΑ
						1 .
Rank 30-01UYC		(1)	(2)	(3)		

# Rank

1	1	1	
•	1	,	

	(1) VF(V)	)	(2) d(nm)		(3) v(mlm)			
Bin	Min	Max	Bin	Min	Max	Bin	Min	Max
0	1.9	2.1	1	586	590	L	1425	1800
1	2.1	2.3	2	590	594	M	1800	2250
2	2.3	2.5				N	2250	2850
3	2.5	2.7				P	2850	3600

LifecyclePhase:

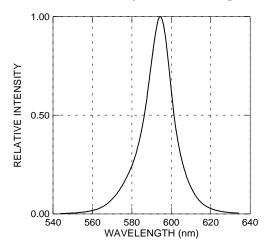
<sup>\*</sup>Measurement Uncertainty of Forward Voltage: ±0.1V

<sup>\*</sup>Measurement Uncertainty of Luminous Intensity: ±15%

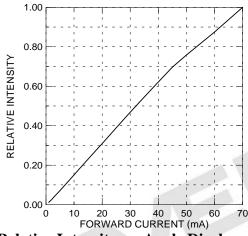
<sup>\*</sup>Measurement Uncertainty of Dominant Wavelength ±1.0nm

# **Typical Electro-Optical Characteristics Curves**

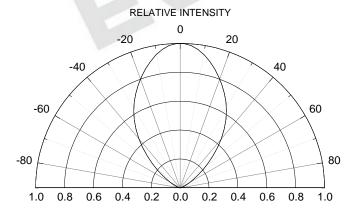
## Relative Intensity vs. Wavelength



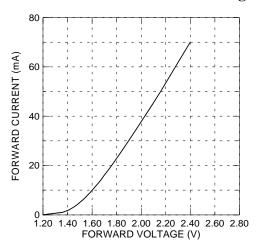
## **Relative Intensity vs. Forward Current**



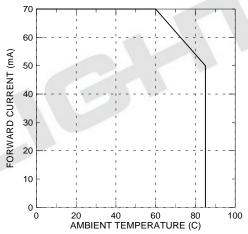
Relative Intensity vs. Angle Displacement



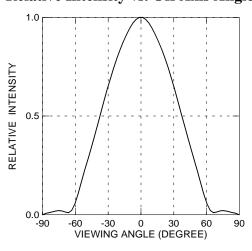
## Forward Current vs. Forward Voltage



Forward Current vs. Ambient Temp.



Relative Intensity vs. Off Axis Angle



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# **Packing Quantity Specification**

80 pcs/1 tube, 36 tubes/1 small inside box, 9 small inside boxes/1 outside box

# **Label Form Specification**

MADE IN TAIWAN

CPN: Customer's Production Number

QTY: Packing Quantity

CAT: Ranks of Total Flux and Forward Voltage

HUE: Ranks of Dominant Wavelength

**REF:** Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

**Expired Period: Forever** 

#### **Notes**

## 1. Lead Forming

- During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
- Lead forming should be done before soldering.
- Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
- When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

## 2. Storage

- The LEDs should be stored at 30°C or less and 60%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

#### 3. Soldering

- Careful attention should be paid during soldering. Solder the LED no lower than 1.6mm from the base of stopper is recommended.
- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.

■ Recommended soldering conditions:

Han	d Soldering	DIP Soldering		
Temp. at tip of iron	300 Max. (30W Max.)	Preheat temp.	100 Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp.	260 Max.	
Distance	No lower than 1.6mm from	Bath time.	5 sec Max.	
	the base of stopper			
		Distance	No lower than 1.6mm from	
			the base of stopper	

- Dip and hand soldering should not be done more than one time.
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.

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- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or handsoldering at the lowest possible temperature is desirable for the LEDs.
- Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

## 4. Cleaning

- When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED

## 5. Heat Management

- Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
- The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.

## 6. ESD (Electrostatic Discharge)

- Electrostatic discharge (ESD) or surge current (EOS) can damage LEDs.
- An ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling LEDs.
- All devices, equipment and machinery must be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing.

## 7. Other

- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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